ON Semiconductor

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RURP15100-F085 15A 1000V Ultrafast Rectifier

Features

- High Speed Switching (t_{rr} =200ns(Typ.) @ I_F =15A)
- Low Forward Voltage(V_F=1.8V(Max.) @ I_F=15A)
- · Avalanche Energy Rated
- · AEC-Q101 Compliant

Applications

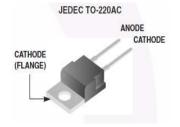
- · Automotive DCDC converter
- · Automotive On Board Charger
- · Switching Power Supply
- · Power Switching Circuits

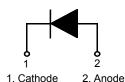
15A, 1000V Ultrafast Rectifier

The RURP15100-F085 is an ultrafast diode with soft recovery characteristics (trr< 200ns). It has a low forward voltage drop and is of silicon nitride passivated, ionimplanted, epitaxial construction.

This device is intended for use as a freewheeling/ clamping diode and rectifier in a variety of automotive power supplies and other power switching automotive applications. Its low stored charge and ultrafast recovery with soft recovery characteristics minimizes ringing and electrical noise in many power switching circuits, thus reducing power loss in the switching transistor.

Pin Assignments





Absolute Maximum Ratings T_C = 25°C unless otherwise noted

| Symbol | Parameter | Ratings | Units | | |
|----------------------------------|---|-----------|-------|--|--|
| V _{RRM} | Peak Repetitive Reverse Voltage | 1000 | V | | |
| V _{RWM} | Working Peak Reverse Voltage | 1000 | V | | |
| V _R | DC Blocking Voltage | 1000 | V | | |
| I _{F(AV)} | Average Rectified Forward Current @ T _C = 25°C | 15 | Α | | |
| I _{FSM} | Non-repetitive Peak Surge Current | 45 | Α | | |
| E _{AVL} | Avalanche Energy(1A,40mH) | 20 | mJ | | |
| T _{J,} T _{STG} | Operating Junction and Storage Temperature | - 55 ~175 | °C | | |

Thermal Characteristics T_C = 25°C unless otherwise noted

| Symbol | Parameter | Max | Units |
|-----------------|---|------|-------|
| $R_{\theta JC}$ | Maximum Thermal Resistance, Junction to Case | 0.94 | °C/W |
| $R_{\theta JA}$ | Maximum Thermal Resistance, Junction to Ambient | 85 | °C/W |

Package Marking and Ordering Information

| Device Marking | Device | Package | Tube | Quantity |
|----------------|----------------|----------|------|----------|
| RURP15100 | RURP15100-F085 | TO-220AC | - | 50 |

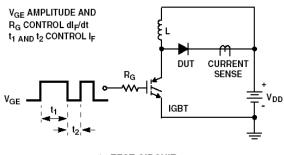
Electrical Characteristics T_C = 25°C unless otherwise noted

| Symbol | Parameter | Conditions | | Min. | Тур. | Max | Units |
|---|---|---|---|-------------|------------------|-------------|----------------|
| I _R | Instantaneous Reverse Current | V _R = 1000V | T _C = 25 °C | - | - | 100 | uA |
| | | | T _C = 175 °C | - | - | 1000 | uA |
| V _F ¹ | Instantaneous Forward Voltage | I _F = 15A | T _C = 25 °C T _C = 175 °C | - | 1.35 1.14 | 1.8 1.6 | V V |
| t _{rr} ² | Reverse Recovery Time | $I_F = 1A$, di/dt = 100A/ μ s, $V_R = 650V$ | T _C = 25 °C | - | 126 | 260 | ns |
| | | I_F =15A, di/dt = 100A/ μ s, V_R =650V | T _C = 25 °C T _C = 175 °C | - | 200 720 | 450 - | ns ns |
| t _a t _b Q _{rr} | Reverse Recovery Time Reverse Recovery Charge | $I_F = 15A$, di/dt = $100A/\mu s$, $V_R = 650V$ | T _C = 25 °C | - - - | 63 137 683 | - - - | ns ns nC |
| W _{AVL} | Avalanche Energy | I _{AV} =1.0A, L=40mH | • | 20 | - | - | mJ |

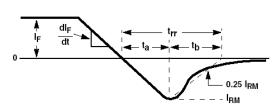
Notes:

- 1. Pulse : Test Pulse width = 300μs, Duty Cycle = 2%
- 2. Guaranteed by design.

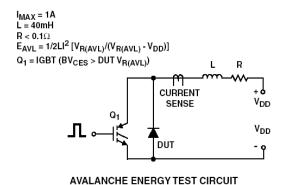
Test Circuit and Waveforms

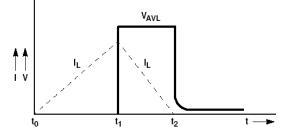


trr TEST CIRCUIT



trr WAVEFORMS AND DEFINITIONS





AVALANCHE CURRENT AND VOLTAGE WAVEFORMS

Typical Performance Characteristics

Figure 1. Typical Forward Voltage Drop vs. Forward Current

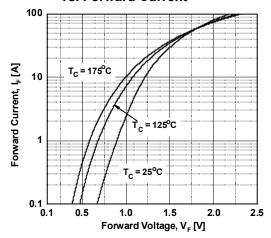


Figure 3.Typical Junction Capacitance

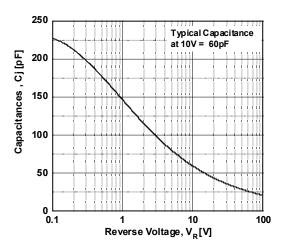


Figure 5. Typical Reverse Recovery Current vs. di/dt

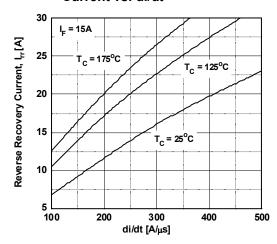


Figure 2. Typical Reverse Current vs. Reverse Voltage

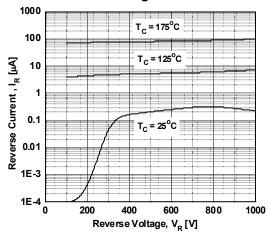


Figure 4. Typical Reverse Recovery Time vs. di/dt

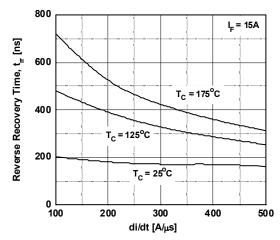
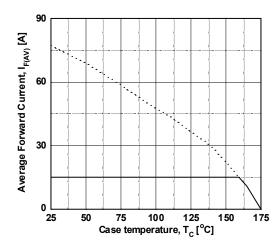


Figure 6. Forward Current Derating Curve



Typical Performance Characteristics (Continued)

Figure 7. Reverse Recovery Charge

6000

I_F = 15A

T_C = 175°C

T_C = 125°C

T_C = 25°C

Figure 8. Transient Thermal Response Curve

300

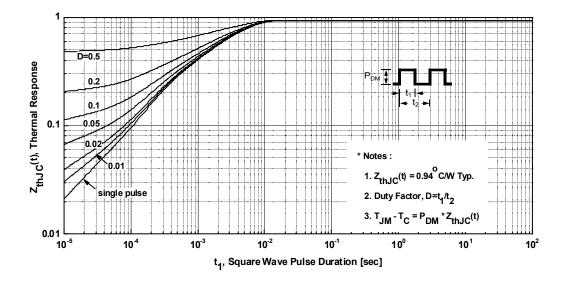
di/dt [A/μs]

400

500

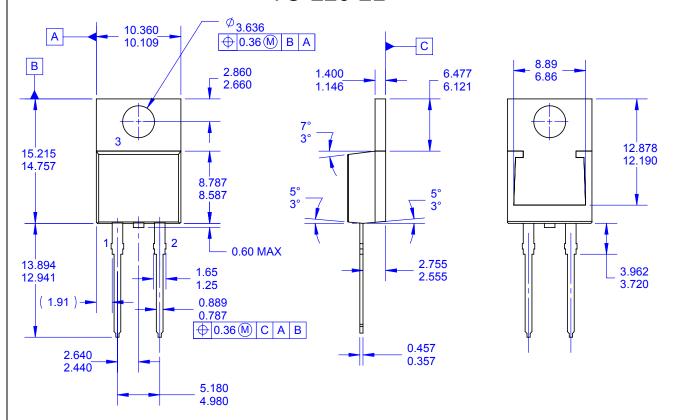
200

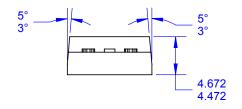
0 L 100



Mechanical Dimensions

TO-220-2L





NOTES:

- A. PACKAGE REFERENCE: JEDEC TO220 VARIATION AC.
- B. ALL DIMENSIONS ARE IN MILLIMETERS. C. DIMENSION AND TOLERANCE AS PER ASME
- Y14.5-2009
- D. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR PROTRUSIONS. E. DRAWING FILE NAME: TO220B02REV5

Dimensions in Millimeters

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